OVSARGB4R8



Features:

- Surface mount device packaged in 8mm tape on 7" diameter reel
- Compatible with automatic placement equipment
- Compatible with infrared and vapor phase reflow solder
- Dimensions: 3.5 x 2.8 x 1.9 mm



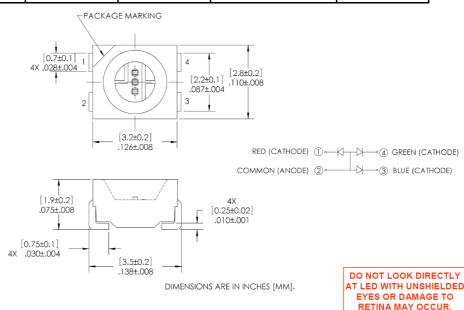
Description:

The OVSARGB4R8 provides full color light output from a single package, 3-die design. This surface mount package is an efficient solution in modular applications that require uniform brightness and color-on-demand. Light output is optimized by an interior reflector and the wide viewing angle adds flexibility for applications ranging from hand-held appliances to automotive interiors.

Applications:

- RGB full-color indoor and outdoor displays
- Backlighting
- Coupling into light guides
- Automotive interiors
- Entertainment equipment

Part Number		Lens Color			
	Туре	Material	Emitted Color	Intensity Typ. Mcd	
OVSARGB4R8	R G	AllnGaP InGaN	Red Green	635 1000	Diffused
	В	InGaN	Blue	335	



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Absolute Maximum Ratings $T_A = 25^{\circ} C$ unless otherwise noted

DADAMETER					
PARAMETER	R	G	В	UNIT	
Storage Temperature		-40 ~ +100		°C	
Operating Temperature		-40 ~ +100			
Reverse Voltage		5			
Continuous Forward Current (1 chip on)	50	25	25	mA	
Peak Forward Current (10% Duty Cycle, PW ≤ 100 µsec, 1 chip on)	200	100	100	mA	
Power Dissipation	130	100	100	mW	
Junction Temperature	110	110	110	°C	
Junction/ambient (1 chip on)	450	400	450	°C/W	
Junction/ambient (3 chips on)	650	580	680	°C/W	
Junction/solder point (1 chip on)	300	280	300	°C/W	
Junction/solder point (3 chips on)	450	430	480	°C/W	
Electrostatic Discharge Classification (JEDEC-JESD22-A114F)					
Moisture Sensitivity Level (IPC/JEDEC J-STD-020C)					

Electrical Characteristics

 $T_A = 25^{\circ} C$ unless otherwise noted

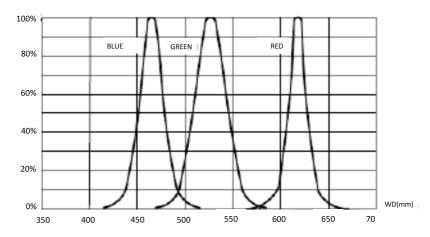
SYMBOL	PARAMETER	VALUES				LINIT	CONDITIONS
STWBUL	PARAMETER		R	G	В	UNIT	CONDITIONS
l _V	Luminous Intensity	Min	450	710	224	mcd	I _F = 20 mA
		Тур	635	1000	335		
V _F	Forward Voltage	Тур	2.0	3.2	3.2	V	I _F = 20 mA
		Max	2.6	4.0	4.0		
I_R	Reverse Current (max)		10	10	10	μΑ	V _R = 5 V
λ_{D}	Dominant Wavelength		619-624	520–540	460–475	nm	I _F = 20 mA
2 Θ½	50% Power Angle		120	120	120	deg	I _F = 20 mA
Δλ	Spectral Radiation Bandwidth		24	38	28	nm	I _F = 20 mA

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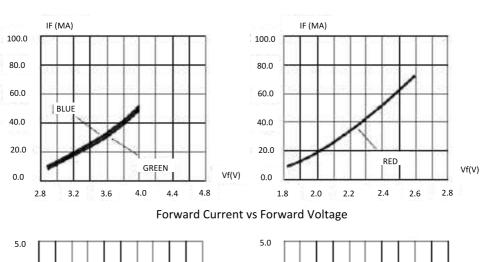
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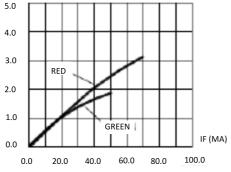


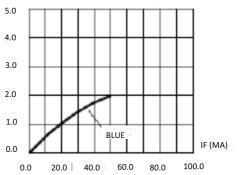
Typical Electro-Optical Characteristics Curves



Relative Intensity vs Dominant Wavelength







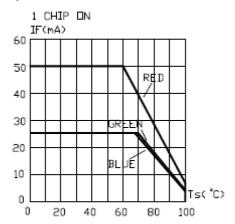
Relative Luminous Intensity vs Forward Current

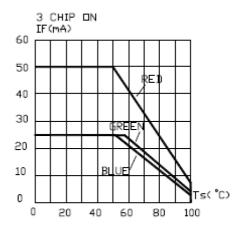
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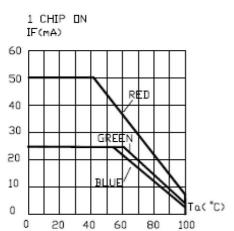


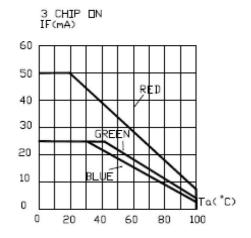
Typical Electro-Optical Characteristics Curves



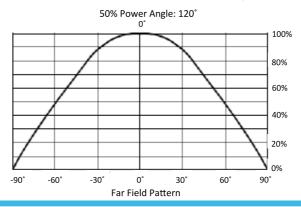


Maximum Forward DC Current vs Solder Point Temperature





Maximum Forward DC Current vs Ambient Temperature



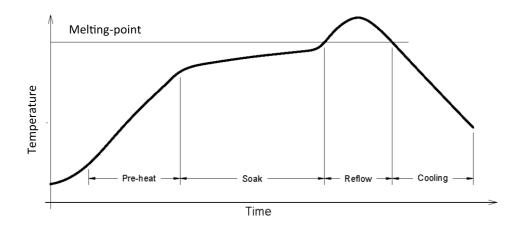
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Reflow Solder Profile

Manual soldering by soldering iron

- The use of a soldering iron of less than 25W is recommended. The temperature of the iron must be kept at below 315°C with soldering time within 2 seconds
- The epoxy resin of the SMD LED should not contact the tip of the soldering iron
- No mechanical stress should be exerted on the resin portion of the SMD LED during soldering.
- Handling of the SMD LED should be done when the package has been cooled down to below 40°C or less. This is to prevent LED failures due to thermal-mechanical stress during handling.
- The temperature (top surface of the SMD LED) profile is as below:



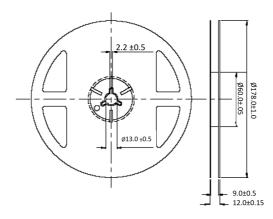
Solder = Lead-Free
Average ramp-up rate = 4°C / sec. max
Preheat temperature: 150 - 200°C
Preheat time: 120 sec. max.
Ramp-down rate = 6°C / sec. max.
Peak temperature = 250°C max.
Time within 5°C of actual peak temperature = 10 sec. max
Duration above 217°C is 60 sec. max

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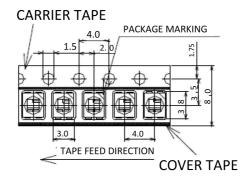
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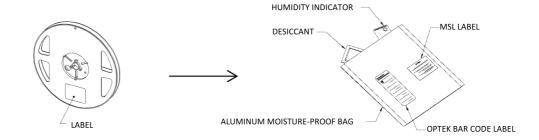
Reel Dimensions: 7-inch reel



Carrier Tape Dimensions: Loaded quantity 2,000 pieces per reel



Moisture Resistant Packaging



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